

Is Now Part of



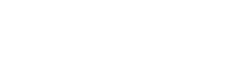
ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at <u>www.onsemi.com</u>

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild_questions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or unavteries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out or i, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that ON Semiconductor was negligent regarding the design or manufacture of the part. ON Semiconductor and is officers, employees, wen if such claim alleges that ON Semiconductor was negligent regarding the des

April 2013



SEMICONDUCTOR

FIN1049 LVDS Dual-Line Driver with Dual-Line Receiver

Features

- Greater than 400 Mbps Data Rate
- 3.3 V Power Supply Operation
- Low Power Dissipation
- Fail-Safe Protection for Open-Circuit Conditions
- Meets or Exceeds TIA/EIA-644-A LVDS Standard
- 16-pin TSSOP Package Saves Space
- Flow-Through Pinout Simplifies PCB Layout
- Enable/Disable for all Outputs
- Industrial Operating Temperature Range: -40°C to +85°C

Description

This dual driver-receiver is designed for high-speed interconnects utilizing Low Voltage Differential Signaling (LVDS) technology. The driver accepts LVTTL inputs and translates them to LVDS outputs. The receiver accepts LVDS inputs and translates them to LVTTL outputs. The LVDS levels have a typical differential output swing of 350 mV, which provides for low EMI at ultra-low power dissipation even at high frequencies. The FIN1049 can accept LVPECL inputs for translating from LVPECL to LVDS. The En and Enb inputs are AND-ed together to enable / disable the outputs. The enables are common to all four outputs. A single-line driver and single-line receiver function is also available in the FIN1019.

Ordering Information

| Part Number | Operating Temperature Range | Package | Packing Method |
|-------------|--------------------------------|---|-------------------|
| FIN1049MTCX | -40 to +85°C | 16-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide | Tape and Reel |
| | | | 1 |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |
| | | | |

Pin Configuration R_{IN1-} 16 EN R_{IN1+} • ROUT1 2 15 R_{IN2+} ROUT2 3 14 R_{IN2-} - GND 13 DOUT2-12 · V_{CC} 5 DOUT2+ 11 DIN2 6 DOUT1+ 10 · DIN1 7 9 ENb DOUT1-8 Figure 1. Pin Configuration

Functional Diagram

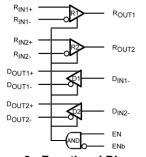


Figure 2. Functional Diagram

Pin Definitions

| Pin # | Name | Description |
|--------|--|---|
| 2, 3 | R _{IN1+} , R _{IN2+} | Non-Inverting LVDS Inputs |
| 1, 4 | R _{IN1-} , R _{IN2-} | Inverting LVDS Inputs |
| 7, 6 | D _{OUT1+} , D _{OUT2+} | Non-Inverting Driver Outputs |
| 8, 5 | D _{OUT1} -, D _{OUT2} - | Inverting Driver Outputs |
| 16, 9 | EN, ENb | Driver Enable Pins for All Outputs |
| 15, 14 | R _{OUT1} , R _{OUT2} | LVTTL Output Pins for R _{OUT1} and R _{OUT2} |
| 10, 11 | D _{IN1} , D _{IN2} | LVTTL Input Pins for D _{IN1} and D _{IN2} |
| 12 | Vcc | Power Supply (3.3 V) |
| 13 | GND | Ground |

Function Table

| Inp | Inputs | | Outputs (LVTTL) Inpu | | LVDS) ⁽¹⁾ | Outputs (LVDS) | |
|-----|--------|-------------------|----------------------|---------------------|----------------------|--------------------|---------------------|
| EN | ENb | R _{OUT1} | R _{OUT2} | R _{INn+} | R _{INn-} | D _{OUTn+} | D _{OUTn} - |
| н | L | ON | ON | | | ON | ON |
| н | Н | Z | Z | | | Z | Z |
| L | Н | Z | Z | | | Z | Z |
| L | L | Z | Z | - | | Z | Z |
| Н | L | Н | Н | Open (Fail-Safe | Current Condition | | |

Legend:

H=HIGH Logic Level

L=LOW Logic Level or OPEN

X=Don't Care

Z=High Impedance

Note:

1. Any unused receiver Inputs should be left open.

FIN1049 — LVDS Dual-Line Driver with Dual-Line Receiver

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

| Symbol | Parameter | Min. | Max. | Unit |
|-----------------------------------|---|------|--------|------|
| V _{CC} | Supply Voltage | -0.5 | +4.6 | V |
| V _{IN} | LVDS DC Input Voltage | -0.5 | +4.6 | V |
| V _{OUT} | LVDS DC Output Voltage | -0.5 | +4.6 | V |
| I _{OSD} | Driver Short-Circuit Current (Continuous) | | 10 | mA |
| T _{STG} | Storage Temperature Range | -65 | +150 | °C |
| TJ | Max Junction Temperature | | +150 | °C |
| ΤL | Lead Temperature (Soldering, 10 Seconds) | | +260 | °C |
| ESD Human Body Model, JESD22-A114 | | | ≥ 7000 | V |
| ESD | Machine Model, JESD22-A115 | | ≥ 250 | v |

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

| Symbol | Parameter | Min. | Max. | Unit |
|-----------------|-----------------------------------|------|-----------------|------|
| V _{cc} | Supply Voltage | 3.0 | 3.6 | V |
| V _{ID} | Magnitude of Differential Voltage | 100 | V _{CC} | mV |
| T _A | Operating Temperature | -40 | +85 | °C |

DC Electrical Characteristics

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at $T_A=25^{\circ}C$ and with $V_{CC}=3.3$ V.

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|------------------|---|--|------------|-------|---|-------|
| LVDS Inp | ut DC Specifications (R _{IN1+} , R _{IN1-} , R _{IN2+} , R _{IN2} |) See Figure 3 and Table 1 | | | | |
| V_{TH} | Differential Input Threshold HIGH | V _{CM} =1.2 V, 0.05 V, 2.35 V | | 0 | 35 | mV |
| V_{TL} | Differential Input Threshold LOW | | -100 | 0 | | mV |
| V _{IC} | Common Mode Voltage Range | V_{ID} =100 mV, V_{CC} =3.3 V | $V_{ID}/2$ | | V _{CC} - (V _{ID} /2) | V |
| I _{IN} | Input Current | V _{CC} =0 V or 3.6 V, V _{IN} =0 V or 2.8 V | | | ±20 | mA |
| CMOS/ L\ | /TTL Input DC Specifications (EN, ENb, DIN | 11, D _{IN2}) | | | | |
| V _{IH} | Input High Voltage (LVTTL) | | 2.0 | | V _{CC} | V |
| VIL | Input Low Voltage (LVTTL) | | GND | | 0.8 | V |
| I _{IN} | Input Current (EN, ENb, D _{IN1} , D _{IN2} , R _{INx+} , R _{INx-}) | V _{IN} =0 V or V _{CC} | | | ±20 | μA |
| VIK | Input Clamp Voltage | V _{IK} =-18 mA | -1.5 | -0.7 | | V |
| LVDS Out | tput DC Specifications (D _{OUT1+} , D _{OUT1-} , D _{OUT} | 2+, D _{OUT2} -) | | | | |
| V _{OD} | Output Differential Voltage | See Figure 4 | 250 | 350 | 450 | mV |
| ΔV_{OD} | Vod Magnitude Change from | R _L =100 Ω | | | 35 | mV |
| | Differential LOW-to-HIGH | Driver Enabled | | | | |
| Vos | Offset Voltage | See Figure 4 | 1.125 | 1.250 | 1.375 | V |
| ΔV_{OS} | Offset Magnitude Change from Differential LOW-to-HIGH | | | | 25 | mV |
| I _{OS} | Short-Circuit Output Current | D _{OUT+} =0V & D _{OUT-} =0 V, Driver Enabled | | | -9 | mA |
| I _{OSD} | | V _{OD} =0 V, Driver Enabled | | | -9 | mA |
| I _{OFF} | Power-Off Input or Output Current | V _{CC} =0 V, V _{OUT} =0 V or V _{CC} | | | ±20 | mA |
| I _{OZD} | Disabled Output Leakage Current | $\begin{array}{l} \mbox{Driver Disabled,} \\ \mbox{D}_{OUT+}=0 \mbox{ V or } V_{CC} \mbox{ or } \\ \mbox{D}_{OUT-}=0 \mbox{ V or } V_{CC} \end{array}$ | | | ±10 | mA |
| CMOS/LV | TTL Output DC Specifications (R_{OUT1}, R_{OUT} | 2) | | | | |
| V _{OH} | Output High Voltage | I_{OH} =-2 mA, V_{ID} =200 mV | 2.7 | | | V |
| V _{OL} | Output Low Voltage | $I_{OL}=2$ mA, $V_{ID}=200$ mV | | | 0.25 | V |
| I _{OZ} | Disabled Output Leakage Current | Driver Disabled, R _{OUTn} =0 V or V _{CC} | | | ±10 | mA |
| I _{CC} | Power Supply Current ⁽²⁾ | Drivers Enabled, Any Valid Input Condition | | | 25 | mA |
| I _{CCZ} | Power Supply Current | Drivers Disabled | | | 10 | mA |
| CIND | Input Capacitance | LVDS Input | | 3.0 | | pF |
| Соит | Output Capacitance | LVDS Output | | 4.0 | | pF |
| CINT | Input Capacitance | LVTTL Input | | 3.5 | | pF |

Note:

2. Both driver and receiver inputs are static. All LVDS outputs have 100 Ω load. None of the outputs have any lumped capacitive load.

AC Electrical Characteristics

Over-supply voltage and operating temperature ranges, unless otherwise specified. All typical values are at $T_A=25^{\circ}C$ and with $V_{CC}=3.3$ V.

| Symbol | Parameter | Conditions | Min. | Тур. | Max. | Units |
|---|---|-------------------------------------|------|------|------|-------|
| Switching | Characteristics - LVDS Outputs | | | | I. | |
| t PLHD | Differential Propagation Delay LOW-to-HIGH | See Figure 5, Figure 6 | | | 2 | ns |
| t _{PHLD} | Differential Propagation Delay HIGH-to-LOW | | | | 2 | ns |
| t _{TLHD} | Differential Output Rise Time (20% to 80%) | | 0.2 | | 1.0 | ns |
| t _{THLD} | Differential Output Fall Time (80% to 20%) | | 0.2 | | 1.0 | ns |
| t _{SK(P)} | Pulse Skew t _{PLH} - t _{PHL} | | | | 0.35 | ns |
| t _{SK(LH),} t _{SK(HL)} | Channel-to-Channel Skew ⁽³⁾ | | | | 0.35 | ns |
| t _{SK(PP)} | Part-to-Part Skew ⁽⁴⁾ | | | | 1 | ns |
| t _{PZHD} | Differential Output Enable Time, Z-to-HIGH | See Figure 7, Figure 8 | | | 6 | ns |
| t _{PZLD} | Differential Output Enable Time, A-to-LOW | | | | 6 | ns |
| t PHZD | Differential Output Disable Time, HIGH-to-Z | | | | 3 | ns |
| t _{PLZD} | Differential Output Disable Time, LOW-to-Z | | N., | | 3 | ns |
| f _{MAXD} | Maximum Frequency ⁽⁵⁾ | See Figure 5 | 200 | | | MHz |
| Switching | Characteristics - LVTTL Outputs | | | | | |
| t _{PHL} | Propagation Delay HIGH-to-LOW | Measured from 20% to 80% Signal | 0.5 | 1.0 | 3.5 | ns |
| t _{PLH} | Propagation Delay LOW-to-HIGH | V _{ID} =200 mV | 0.5 | 1.0 | 3.5 | ns |
| t _{SK1} | Pulse Skew | Distributed Load | 0 | 35 | 400 | ps |
| t _{SK2} | Channel-to-Channel Skew | $C_L=15 \text{ pF}$ and 50 Ω | 0 | 50 | 500 | ps |
| t _{SK3} | Part-to-Part Skew | R _L =1 kΩ | 0 | | 1 | ns |
| t _{LHR} | Transition Time LOW-to-HIGH | V _{OS} =1.2 V | 0.10 | 0.25 | 1.40 | ns |
| t _{HLR} | Transition Time HIGH-to-LOW | See Figure 9, Figure 10 | 0.10 | 0.18 | 1.40 | ns |
| t _{PHZ} | Disable Time HIGH-to-Z | See Figure 11, Figure 12 | 2.2 | 4.5 | 8.0 | ns |
| t _{PLZ} | Disable Time LOW-to-Z | | 1.3 | 3.5 | 8.0 | ns |
| t _{РZH} | Enable Time Z-to-HIGH | | 1.8 | 3.0 | 7.0 | ns |
| t _{PZL} | Enable Time Z-to-LOW | | 0.9 | 1.4 | 7.0 | ns |
| f _{MAXT} | Maximum Frequency ⁽⁶⁾ | See Figure 9 | 200 | | | MHz |

Notes:

3. $t_{SK(LH)}$, $t_{SK(HL)}$ is the skew between specified outputs of a single device when the outputs have identical loads and are switching in the same direction.

 t_{SK(PP)} is the magnitude of the difference in propagation delay times between any specified terminals of two devices switching in the same direction (either LOW-to-HIGH or HIGH-to-LOW) when both devices operate with the same supply voltage, same temperature, and have identical test circuits.

5. f_{MAXD} generator input conditions: $t_r=t_f < 1$ ns (10% to 90%), 50% duty cycle, 0 V to 3 V. Output criteria: duty cycle=45% / 55%, $V_{OD} > 250$ mV, all channels switch.

6. f_{MAXT} generator input conditions: $t_r=t_f < 1$ ns (10% to 90%), 50% duty cycle, $V_{ID}=200$ mV, $V_{CM}=1.2$ V. Output criteria: duty cycle=45% / 55%, $V_{OH} > 2.7$ V. $V_{OL} < 0.25$ V, all channels switching.

Required Specifications and Test Diagrams

Notes:

- 7. Electrostatic Discharge Capability: Human Body Model and Machine Model ESD should be measured using MIL-STD-883C method 3015.7 standard.
- 8. Latch-up immunity should be tested to the EIA/JEDEC Standard Number 78 (EIA/JESD78).

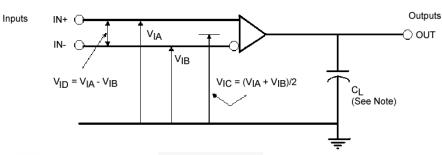


Figure 3. Differential Receiver Voltage Definitions Test Circuit

Note:

9. C_L=15 pF, includes all probe and jig capacitances.

| Table 1. | Receiver Minimum and Maximum Input Threshold Test Voltages |
|----------|--|
|----------|--|

| Applied | Voltages (V) | Resulting Differential Input Voltage (mV) | Resulting Common Mode Input Voltage (V) | | |
|-----------------------|-----------------------|--|--|--|--|
| VIA | V _{IB} | V _{ID} | V _{IC} | | |
| 1.25 | 1.15 | 100 | 1.2 | | |
| 1.15 | 1.25 | -100 | 1.2 | | |
| V _{CC} | V _{CC} - 0.1 | 100 | V _{CC} - 0.05 | | |
| V _{CC} - 0.1 | V _{cc} | -100 | V _{CC} - 0.05 | | |
| 0.1 | 0.0 | 100 | 0.05 | | |
| 0.0 | 0.1 | -100 | 0.05 | | |
| 1.75 | 0.65 | 1100 | 1.2 | | |
| 0.65 | 1.75 | -1100 | 1.2 | | |
| V _{CC} | V _{CC} - 1.1 | 1100 | V _{CC} - 0.55 | | |
| V _{CC} - 1.1 | V _{cc} | -1100 | V _{CC} - 0.55 | | |
| 1.1 | 0.0 | 1100 | 0.55 | | |
| 0.0 | 1.1 | -1100 | 0.55 | | |

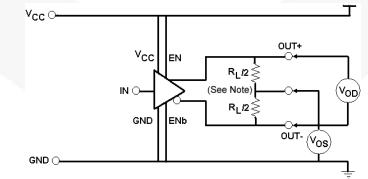
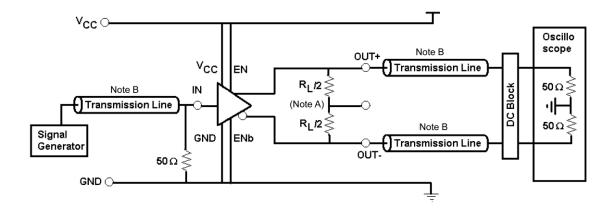


Figure 4. LVDS Output Circuit for DC Test

Note:

10. $R_L{=}100~\Omega.$

Required Specifications and Test Diagrams (Continued)

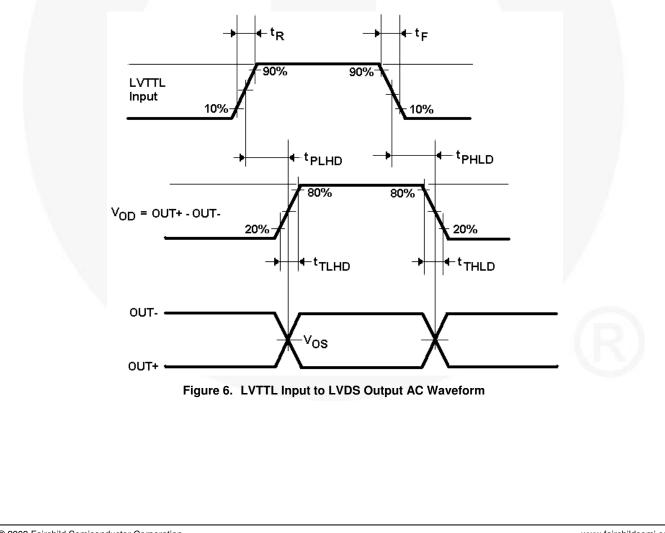


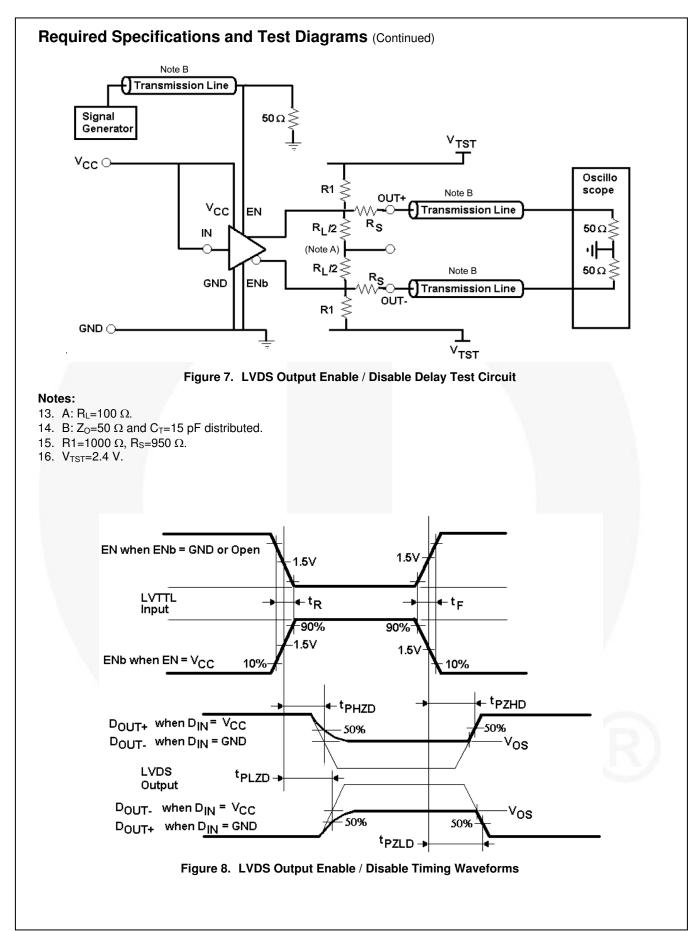


Notes:

11. A: R_L=100 Ω.

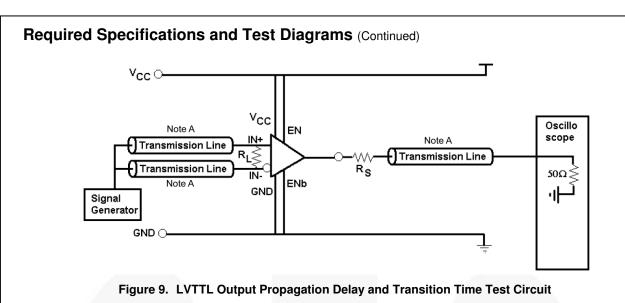
12. B: $Z_0=50 \Omega$ and $C_T=15 \text{ pF}$ distributed.





FIN1049 — LVDS Dual-Line Driver with Dual-Line Receiver

8



Notes:

- 17. A: $Z_0=50 \Omega$ and $C_T=15 pF$ distributed.
- 18. R_L =100 Ω and R_S =950 Ω .

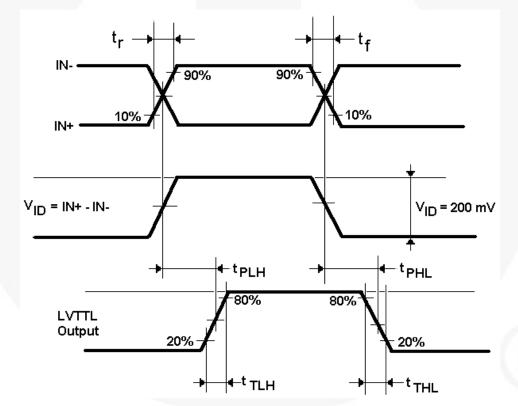
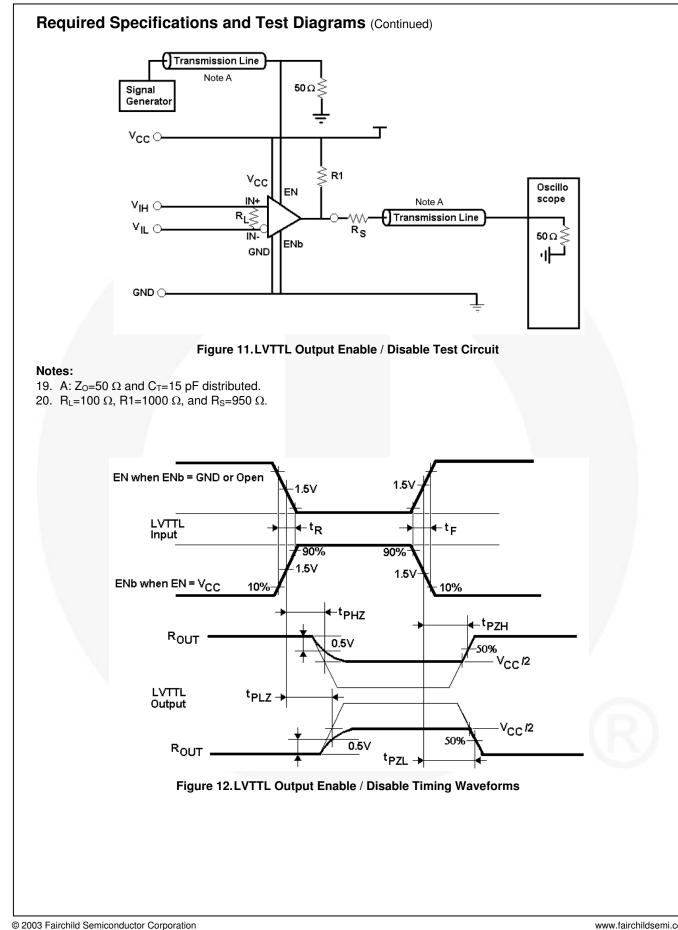
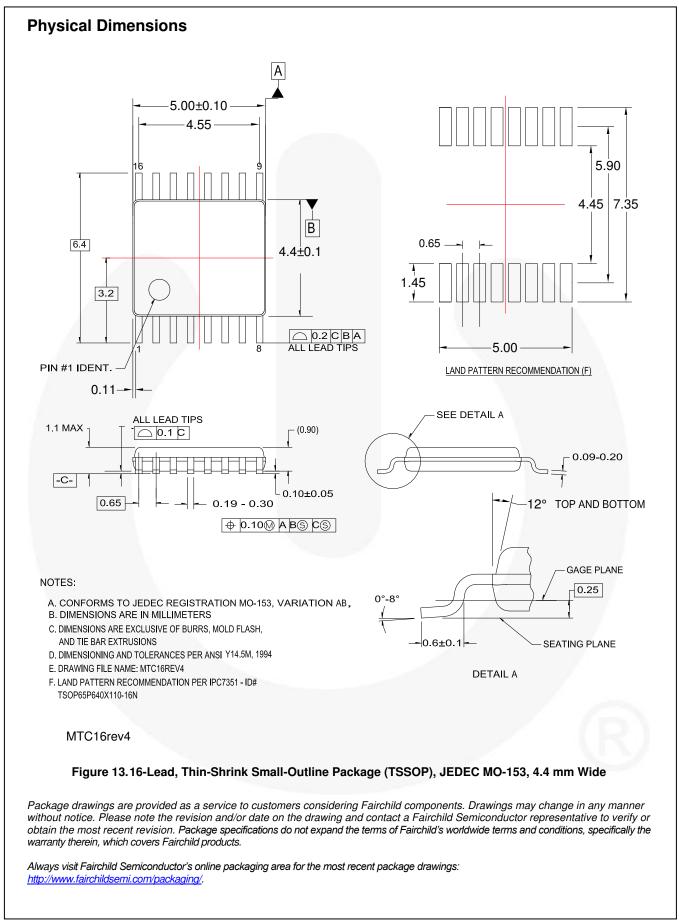


Figure 10. LVDS Input to LVTTL Output Propagation Delay and Transition Time Waveforms



10

FIN1049 • Rev. 1.0.3



FAIRCHILD SEMICONDUCTOR TRADEMARKS The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks. Sync-Lock™ 2Cool™ FPSTM AccuPower™ AX-CAP[®]* F-PFS™ GENERAL® FRFET® PowerTrench® BitSiC™ Global Power Resource^s TinyBoost™ PowerXS™ GreenBridge™ Build it Now™ TinyBuck™ Programmable Active Droop™ CorePLUS™ Green FPS™ OFET TinyCalc™ Green FPS™ e-Series™ CorePOWERTM TinyLogic® OSTM. Gmax™ CROSSVOLT TINYOPTO Quiet Series™ CTL™ GTOTM TinyPower™ RapidConfigure™ IntelliMAXTM TinyPWM™ Current Transfer Logic™ **ISOPLANAR™** DEUXPEED® TinyWire™ Saving our world, 1mW/W/kW at a time™ Making Small Speakers Sound Louder Dual Cool™ TranSiC™ SignalWise™ EcoSPARK[®] and Better™ TriFault Detect™ SmartMax™ EfficientMax™ MegaBuck™ TRUECURRENT®* SMART START MICROCOUPLER[™] **ESBC™** uSerDes™ Solutions for Your Success™ R MicroFET F SPM⁶ MicroPak™ Fairchild® STEALTH MicroPak2™ UHC® Fairchild Semiconductor® SuperFET[®] MillerDrive™ Ultra FRFET™ FACT Quiet Series™ SuperSOT™-3 MotionMax™ UniFET™ FACT® FAST® SuperSOT™-6 mWSaver™ VCXT SuperSOT™-8 OptoHiT™ VisualMax™ FastvCore™ SupreMOS® **OPTOLOGIC®** VoltagePlus™ FETBench™ SyncFETTM **OPTOPLANAR®** XSTM

* Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used herein:

- Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS

| Datasheet Identification | Product Status | Definition |
|--------------------------|-----------------------|--|
| Advance Information | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice. |
| Preliminary | First Production | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design. |
| Obsolete | Not In Production | Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only. |

Rev. 164

ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent-Marking.pdf</u>. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor has against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death ass

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81-3-5817-1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

© Semiconductor Components Industries, LLC